HIGH SPEED DIRECT-WRITE FOR RAPID FABRICATION OF THREE-DIMENSIONAL MICROFLUIDIC DEVICES

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ABSTRACT

The objective of this research is to adapt the fabrication of cylindrical microchannels by directed assembly for industrial purposes. The directed assembly consists of the extrusion of a fugitive organic ink through a micro-nozzle under constant pressure combined with a layer-by-layer robotic deposition on a substrate for the creation of geometrically complex structures. A multi-axis motion platform has been developed in order to adapt this technique to rapid fabrication. This platform and custom-made software enable the writing of two-dimensional and three-dimensional (2D and 3D) ink networks at a high velocity and positioning accuracy. Improvements on the hardware, software and communication integration were accomplished on this dedicated platform in order to achieve the fast fabrication of precise 3D microstructures. Under similar deposition conditions, the platform developed allowed maximum deposition velocities of more than one order of magnitude superior to the usual writing speeds (i.e., between 1 to 8mm/s). The filaments deposited were characterized by laser scanning profilometry and optical microscopy. The deposition trajectories at high-speed were customized and the smooth roughness of the filament surface was preserved. Finally, the ink structures have been embedded in an epoxy and subsequently removed to create 3D microfluidic networks in order to demonstrate the potential of such platform.

1. INTRODUCTION

Three-dimensional periodic microstructures may find widespread technological applications as sensors [1], composites [2], heat exchangers [3], and in tissue engineering [4]. Current silicon-based technologies require several alignments and bonding processes to create a simple device of a few layers. Eutectic and fusion bonding, for instance, carry the wafer at high temperatures that may not be compatible with the other systems integrated to the device [5]. On the other hand, direct ink and laser writing techniques were used to efficiently produce complex two-dimensional and three-dimensional (2D and 3D) structures with high aspect ratios [6]. Direct ink writing, in particular, is the only microfabrication process capable of creating multilayer periodic structures in a single iteration. However, the integration of microfluidic structures in application devices raises a challenge for the industries. Despite a substantial amount of research invested in microfluidics development, little effort has been devoted to their practical integration. The latter requires attention, and direct ink writing techniques can provide a solution.

The direct-write assembly consists of the robotic deposition of 2D or 3D ink patterns on a substrate [6]-[11]. For the fabrication of microfluidic networks, the process is shown in the Fig. 1. First, an organic ink is extruded through a cylindrical micronozzle under constant pressure. The ink-based pattern is then infiltrated with an epoxy and upon curing, the ink is removed by heating the structure to yield a 2D or 3D microfluidic network comprised of microchannels (~100-250μm in diameter) [12]. In addition, stronger viscoelastic organic inks composed of a microcrystalline wax were designed in order to deposit more complex 3D structures on the substrate [13]. The ink deposition is the critical step of this microfluidic fabrication procedure.

Previous work on direct ink writing of 3D structures includes mesoscale periodic structures fabricated using a robotic deposition rates varying between 2-8mm/s of colloidal inks filaments of cylindrical diameter varying from 100μm to 1mm [8] [9], colloidal ink with a hexagonal shape of vertex-to-vertex diameter of 560μm deposited at 2 mm/s to build 3D structures [10], and smaller 3D scaffolds made of polyamide rich were also produced [11] using a more accurate robot (ABL9000, Aerotech) used for wafers microfabrication prototyping. The diameter of the micro-nozzle was 1μm and the overall dimension of the structures was between 100μm and 200μm. The robotic deposition was performed at 40μm/s. More specific work on microfluidics...
components has been achieved using an organic ink [13]. Microfluidic devices with hydraulic diameter of 100μm to 250μm have been built [11] [14]. The maximum writing/deposition rates of the channels were between 6mm/s and 8mm/s (JL2000, Robocasting Enterprises, Inc.).

Until now, direct-write techniques are rarely used for industrial mass production mainly because of the slow linear deposition process involved. Although microfluidic devices made using organic ink are of great interest, the writing speeds must be increased in order to demonstrate their viability for high volume production. Commercially available robots such as Cartesian laboratory robots can perform directed assembly technique. Although generally used for non-viscous point-to-point fluid dispensing, these robots can also be used for continuous depositions. These robots are economical (≈10000-20000$), easy to install and usually come with a user-friendly general-purpose software. A typical example is the J2200 Fisnar or Ultra TT, EFD that enables relatively accurate positioning (repeatability: 10-25μm) at moderate deposition speeds (1-15mm/s), which are appropriate for prototyping purposes. However, these cable drive stages cannot perform tight contour deposition (<500μm) at high speed (>15mm/s). Writing rates experiments have been performed using the J2200 which shows to be effective at moderate speeds as shown in Fig. 2. Figures 2b and 2c illustrate that the quality of the microstructures is significantly affected at higher speeds. The increase of the deposition speed to 20mm/s, with a non maximum payload, causes the upper structure to oscillate during direction changes. Moreover, despite the speed limitation, these machines have limited memory for waypoints trajectories and external real-time control is not possible. These limitations must be addressed in order to define the real capabilities of this technique.

Here, we present significant advancements for high speed and accurate ink deposition for the creation of 3D microfluidic devices. A new high performance robotic platform with custom coded software was assembled successfully. The high-speed depositions achieved with this platform under different speeds, geometries, ink-viscosities and diameters were characterized by laser scanning profilometry and optical microscopy.

2. EXPERIMENTAL SETUP

The platform designed for high-speed microfabrication by direct-write assembly consists of a four degree of freedom positioning stage that accurately moves the extrusion system and/or the substrate at speeds reaching 88mm/s for continuous three-dimensional motions and up to 100mm/s for two-dimensional patterns. For maximum stage velocity and accuracy, a combination of Cartesian, cylindrical and gantry configurations was selected for the design of the deposition platform, as shown in Fig. 3a. Linear servo motors with linear mechanical bearings were used for the XY and Z positioning. The axes are separated into two groups of two (i.e., axes x and y; axes z and θ) in order to minimize the system inertia. The two positioning groups are fixed onto a massive custom-made granite structure (~1000 kg, Standridge Granite Corp.) for high dynamic stability of the platform during operation. The flatness of the granite structure was controlled (~2µm/ft) in order to maintain proper alignment between the two positioning groups over the whole traveling range. A high capacity air-piston table (pressure of 652 kPa, 68-500 Series, Harvard Apparatus Canada) ensures the active damping of oscillations caused by the stage motions during depositions.

The displacement bearings for horizontal motion of Fig. 3a are supported by large cross-sections while still maintaining an overall low profile to decrease deviations in straightness and flatness. The short distance between the bearings combined with a linear DC amplifier enable superior contour-motion profiles. This design has been selected in order to deposit dense parallel microchannels at high speed. A center-driven linear motor, which is controlled by a pulse width modulation (PWM) digital amplifier, is used for vertical positioning. Two pneumatic counter-balances have been adjusted on both sides of the stage to simulate a zero gravity environment when the motor is not powered. The fourth degree of freedom is provided by a rotary direct-drive brushless servomotor mounted under the vertical axis, which is also controlled by a PWM digital amplifier. The four amplifiers are interconnected, and controlled through a firewire (IEEE-1394) connection to a computer.

A high-pressure dispenser (HP7x, EFD) is mounted on a metallic holder under the rotary motor. This dispensing tool contains a 3cc syringe barrel and a piston that multiplies the input air pressure by a factor of 7. An air-operated dispenser (Ultra 2400, EFD) is used to regulate the air pressure from 0 to 689 kPa via the parallel port of the computer. As shown in Fig. 3b, a laser scanner (LK-G82, Keyence) has been mounted next to the syringe for roughness measurements.
This laser system uses a CCD lens to measure the distance by triangulation with a resolution of 0.2µm.

3. SOFTWARE ENVIRONMENT

The deployment of any industrial microfabrication platform involves a substantial amount of software development. How the positioning system is programmed, configured and controlled has an important influence on its performance. At the microscale, geometries imposed by the structures may involve millions of waypoints in order to keep a desired level of precision, and to conserve a constant velocity vector among all axes. To obtain conformed structures, the waypoints need to be synchronized on all positioning axes. Therefore, the need for a hard real-time system (i.e., response time in the order of ~μs) is necessary.

3.1 System architecture

A C/C++ class library combined with a Win32 application programming interface (API) has been developed in order to provide real-time intuitive control of the platform. This interface is running over Windows XP on a standard PC (Intel Pentium 4, 3.2 GHz, 512 MB of RAM). As opposed to programmable logic controllers (PLC), computer-based automations involve real-time responses at the PC level and interruptions in Windows XP/2000 cannot be managed in less than 100 ms. While Windows Embedded products can provide a hard real-time environment on a PC, the drivers’ interface hardware needs to be programmed when not provided by manufacturers. Real-time Linux also offers very serviceable performance for real-time processing, yet most component-manufacturers do not provide Linux drivers. As a result, the Real-Time Extension (RTX) runtime environment proved to be the best choice for this platform operating under Windows. Its kernel runs besides Windows kernel to provide precise control of interrupt requests, input/output accesses and memory without interfering with Windows’ infrastructure as presented in Fig. 4a. It provides deterministic time-responses to real-time applications, and its typical thread latency service interruptions are less than 1μs.

Fig. 4b presents the architecture of the motion system used. A part of the RAM is reserved during the initialization for the direct communication with the firewire interface. This procedure avoids the pagination and swapping of that memory that slows down the communication by a factor of approximately one million due to hard drive access. Commands sent by the application through the system library are processed on a first priority fixed by RTX, and queued in that shared memory. The synchronized motion control engine manages the subsequent communication protocols, thus ensuring that the right command is sent to the right microcontroller. The same communication channel is used for the information transmitted from the controllers to the applications. This configuration allows millions of points physically separated by a few tens of microns to be sent on a limited sized memory, and processed by the stage microcontrollers with acceptable latency delays.

3.2 Curve parameterization

Deposition trajectories such as sharp corners are difficult to deposit at high-speed because of the abrupt changes in direction. The displacement system incorporates a continuous motion option, which allows the platform to keep an apparent constant speed during the whole deposition process. As such, the controller executes a subtle round corner, and increases the current to the motors, thus maximizing the acceleration in the new direction vector. If it exceeds the available or possible current, a flag is asserted and the stage is stopped. Since the filament is deposited at a constant pressure for a given speed, any mismatch between the extrusion linear flow rate and the stage velocity will alter the diameter of the ink filament. This parameter is even more important for multi-layer structures since the integrity of each layer depends on the supporting layers underneath. Thus, we applied and tested a B-Spline algorithm on control points sent by the user in order to reach a maximum and stable velocity for different deposition trajectories. The B-Spline curve is defined over a parameter \( u \), using the following equation [15]:

\[
C(u) = \sum_{i=0}^{n} P_{i}(u)
\]

\[
N_{i,0}(u) = \begin{cases} 
1 & \text{if } u_{i} \leq u \leq u_{i+1} \\
0 & \text{otherwise}
\end{cases}
\]

\[
N_{i,p}(u) = \frac{u - u_{i}}{u_{i+p} - u_{i}} N_{i,p-1}(u) + \frac{u_{i+p+1} - u}{u_{i+p+1} - u_{i+1}} N_{i+1,p-1}(u)
\]

where \( C(u) \) represents the new curve varying between \( u_{\text{min}} \) and \( u_{\text{max}} \), defined as the nodal vector, the \( n+1 \) control points are denoted \( P_{i} \), the basic functions are denoted \( N_{i,p} \) and \( p \) is the degree of the curve. B-Spline curves are defined inside the convex envelopes of the control points, which prevent any unwanted contact between the channels. As shown in Eq. 2, the basic functions are defined only on a limited band depending on the corresponding value on the nodal vector. Higher degree curves are calculated, as shown in Eq. 3, by a recursive algorithm. This local support offered by the B-Spline makes it prompt and easy to use with a standard computer. A third degree parameterized curve of 100,000 three-dimensional points may be computed in 5 minutes.

The applied algorithm does not necessarily degenerate the shape of the desired structure as in Fig. 5a. On the other
hand, this structure can be sampled before applying the algorithm, thus isolating the sharp corners as shown on Fig. 5b. The curvatures of the microchannels could also be defined using the B-Spline algorithm. At a given point, the curvature is calculated using Eq. 4 for a parametric curve in a Cartesian plan (x, y):

\[ R = \frac{\left( x'^2 + y'^2 \right)^{\frac{3}{2}}}{\left( x''^2 + y''^2 \right)} \]  \hspace{1cm} (4)

4. RESULTS AND DISCUSSION

4.1 Ink characterization

The organic ink used for the deposition is a binary mixture of microcrystalline wax and a lower molecular weight organic phase (gel petroleum). The ink’s elasticity increases linearly with increasing weight fraction of the microcrystalline wax [12]. The ink design is function of three major constraints. First, the cylindrical shape of the extruded ink filament must remain unchanged after the extrusion. Second, the ink mixture must be strong enough to self-support several superimposed layers. Finally, the viscosity of the ink must allow the extrusion through a micronozzle within the maximum applicable pressure available in the experimental setup (4826 kPa in our particular case). Previous work [13] shows that 10 to 40 of weight percent (wt-%) microcrystalline wax exhibits excellent printing behavior under ambient conditions. Using a modest applied pressure, the optimal ink composition is 40wt-%. As shown in Fig. 6, the required pressure for an extrusion that would maintain the proper filament diameter (i.e. 200µm) during 2D deposition increases linearly with the deposition speed for an ink with 20wt-%, 30wt-% and 40wt-% microcrystalline waxes. Therefore, the usage of an ink composition of 40wt-% would be limited to a speed of 60mm/s for a nozzle with an inner diameter of 200µm because the required extrusion pressure would reach the maximum capacity of the setup. The less viscous inks allow higher deposition speeds without compromising the integrity of the extruded filament. The applied pressure for the ink at 20wt-% and 30wt-% of wax during 2D depositions at speeds varying from 10 to 100mm/s are presented in Fig. 6. At 100mm/s, the pressure required for the deposition of the organic ink is 4006 kPa and 3354 kPa respectively, which is still below the maximum pressure of 4826 kPa of the dispenser.

The 20wt-% and 30wt-% ink allows a higher deposition velocity while preserving lower shape retention of the filaments compared to the 40wt-% ink. The polymer channel walls were previously measured [12] with a root-mean-square surface roughness of 13.3±6.5nm using a stylus instrument with high sampling rates. Here, the average roughness of the ink was measured with lower sampling on longer distances in order to determine the deviation of nominal diameter for the different mixtures at different applied pressures and deposition speeds. The average roughness of the ink filament was measured using the laser system presented in Section 2. The measurements were done on the mid section of straight 200µm filaments for the three different mixtures (20wt-%, 30wt-%, 40wt-%) at different speeds and pressures with a standard deviation of 0.47μm.

\[ R_a = \frac{1}{L} \int_0^L \sqrt{y'^2 + y''^2} \, dx \]  \hspace{1cm} (7)

where \( L \) is the length of the measured profile, and \( y \) is the distance from the centre line. Surfaces with known roughness have been tested to validate our roughness measurements, and thus, the laser’s light intensity was adjusted to properly reflect on the ink which is a half transparent material. The distance measurements were done every 1.1µm over a length of 8 mm. The extrusion pressure was set according to the values presented in Fig. 6. A small increase of 1 to 3µm of the filament roughness has been observed when using the 20wt-% and 30wt-% mixture compared to the 40wt-% for writing speeds between 10 to 60mm/s as shown in Fig. 7. The 40wt-% ink presents an average \( R_a \) of 6.9µm through the different speeds and pressures with a standard deviation of 0.62µm. This average is 7.8µm for the 20wt-% ink with a standard deviation of 0.47µm and 7.3µm for the 30wt-% ink.
with a standard deviation of 0.43μm. Although further investigations are required, the ink’s slight differences in roughness under different writing speeds may be due to the rheological response of the ink under different pressures. However, the roughness or the shapes of straight-deposited filaments do not restrain the writing speeds.

4.2 Parameterized depositions

The B-Spline algorithm has been tested for the writing of a 90 degree path at 40mm/s using a filament with a diameter of 100μm. As shown in Fig. 8a, the channel does not preserve its shape during the sharp turn. The sudden change of direction and the resulting acceleration are damageable for the quality of the channels. Figure 8b presents a filament written under the same conditions but using a B-Spline parameterization. This third degree curve is defined with a 200μm step and was calculated in less than a second. The resulting deposited filament is smooth, has a regular cross section and adheres well on the substrate surface.

The deposition was performed under a constant applied pressure for a given nozzle diameter and a deposition speed as in Fig. 6 for a 200μm nozzle. Due to the mechanical time response of the dispensing system used, the applied pressure cannot be rapidly changed in order to maintain a constant filament diameter. Therefore, the goal is to minimize the velocity deviation from the desired value during the writing process even for intense curvature paths. Figure 9a shows the velocity error along the X and Y displacement axes for a 90-degree turn trajectory as shown in Fig. 8a. The absolute maximum velocity error is 72μm/s for the X axis and 40μm/s for the Y axis. Figure 9b shows the errors when using the parameterization algorithm and reductions to 51μm/s for the X axis and 31μm/s for the Y axis are observed. It has also been observed that the transition of the motion from the Y axis to the X axis is much more gradual since it involves a higher quantity of control points. The error for the X axis is slightly higher because of the higher inertia due to the mass of the Y axis motor.

4.3 Three-dimensional depositions

A high aspect ratio 3D scaffold, presented in Fig. 10, has been fabricated at 88mm/s using the 20wt-% microcrystalline wax mixture. This 3D scaffold consists of a 54-layer structure of parallel cylindrical rods of 200μm (d) with an inter-rod separation distance (L) of 1.25 mm (L/d=6.25). The resulting 3D network is a 20 mm × 20 mm × 9.18 mm structure made of a 19.6μm ink filament. The proper alignment of the 54 layers is shown in Fig. 10b. A similar structure of 104 layers was previously produced [13] at a speed of 8mm/s. Even if the writing speed is superior by a factor of more than 10, the 20wt-% microcrystalline wax mixture was not able to support 104 layers. After 54 layers, the structure slowly started to collapse under its own weight. Thus, the preprogrammed routine failed because the superimposed layers have to be written at a specific vertical offset distance of 170μm. Also, the binary mixture made of 30wt-% of microcrystalline wax seems to be more appropriate for a high number of superimposed layers. According to the linear relationship between the extrusion pressure and the deposition speed, this mixture would allow high velocity writing with a higher stiffness. However, the less viscous mixture made of 20wt-% shows a better behavior on continuous dispensing of 3D structures at high velocity.

The 3D scaffold structure has been embedded in an epoxy and cleaned using hot water and high air pressure. Figure 10c shows the resulting microchannel network filled with a fluorescent fluid. The fugitive ink filament (diameter of 200μm) made of 20wt-% microcrystalline wax shows no deformation on a spanning distance of 1.25mm and was not damaged during the epoxy infiltration.

4.4 Microfluidic devices

2D and 3D microfluidic networks can easily be produced with this microfabrication technique. As depicted in Fig. 11, the inks filament can intersect for more sophisticated fluidic designs. Figure 12 shows an example of a microvascular network made of two superimposed and intersecting layers of microchannels (250μm in diameter) deposited with the high performance platform at the speed of 88mm/s. The geometry of the structure is made of parallel diagonal filaments for which the two axis (X and Y) needs to move simultaneously. The writing of the ink filament has been done over a polymethyl polymethacrylate (PMMA) substrate. An epoxy is used as adhesive on multilayer PMMA microfluidic components [16]. The adhesion has bond strengths that prevented delamination or leakage during the ink removal.
process which involves a temperature of 60°C and an air pressure of 620kPa applied inside the microchannels network. The three-dimensional microfluidic component is 2.6mm thick where the epoxy only holds 1mm of thickness. An inlet and an outlet have been incorporated in the component for the cleaning and filling of the network. These inlets/outlets are ink filaments deposited and located outside of the main structure. Finally, micro-tubes (S-54-HL, Tygon) were aligned and fixed to the device in order to allow the filling of the network using a needle of 230μm of outer diameter.

5. CONCLUSION

We have adapted the direct ink writing technique for the high-speed fabrication of 2D and 3D microfluidic devices. The fabrication time is critical for high volume production in the industry. The robotic platform and custom-made software presented in this paper have significantly enhanced the deposition performance. Previously performed between 2mm/s to 8mm/s, 2D depositions can now be achieved at a maximum velocity of 100mm/s and high aspect ratio 3D periodic microstructures were fabricated up to 88mm/s while preserving structural integrity. Viscoelastic properties of the 20wt-% microcrystalline wax ink mixture are the most suitable for high velocity depositions due to lower microextrusion pressure. This less viscous mixture allowed increasing the deposition speed but restricted the possible amount of superimposed layers (50%) and it also slightly increased the average roughness of the channels (~1-2μm) compared to the optimal ink composition (40wt-%). However, this ink was successfully used for the writing of 200μm of hydraulic diameter channels to build 3D microfluidic devices. Several other deposition parameters such as ink elasticity, nozzle inner diameter and structure geometry have an important impact on the final microfluidic component quality and should be fully characterized. Parallel writing is also investigated for a complete optimization of the deposition process Advances in computer engineering and automation science will eventually enable the integration of direct writing microfabrication to the industry for the mass production of 3D microfluidic devices.

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7. REFERENCES


